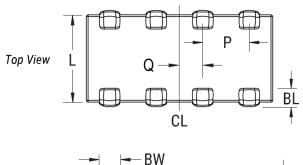


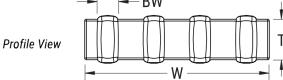
## CA064X270J2GACTU

Aliases (CA064X270J2GAC7800)

Not for New Design

Array Comm COG Flex, Ceramic, 27 pF, 5%, 200 VDC, COG, SMD, MLCC, Array, Flex Termination, Class II, 0612





Click here for the 3D model.

Dimensions	
L	1.6mm +/-0.2mm
W	3.2mm +/-0.2mm
Т	0.8mm +/-0.10mm
Р	0.8mm +/-0.10mm

Pac	kag	ging	Specifications
-			

Packaging Packaging Quantity T&R, 180mm, Paper Tape 4000

General Information	
Series	Array Comm COG Flex
Style	SMD Array
Description	SMD, MLCC, Array, Flex Termination, Class II
RoHS	Yes
Termination	Flexible Termination
AEC-Q200	No
Typical Component Weight	18 mg
Notes	Last Time Buy Date (LTB): May 30th, 2024.
Chip Size	0612
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	27 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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